



US00D786835S

(12) **United States Design Patent**  
**Wu et al.**

(10) **Patent No.:** **US D786,835 S**

(45) **Date of Patent:** **\*\* May 16, 2017**

(54) **COMMUNICATIONS HEADSET**

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(\*\*) Term: **15 Years**

(21) Appl. No.: **29/537,530**

(22) Filed: **Aug. 26, 2015**

**Related U.S. Application Data**

(62) Division of application No. 29/501,381, filed on Sep. 3, 2014, now Pat. No. Des. 754,639.

(51) **LOC (10) Cl.** ..... **14-01**

(52) **U.S. Cl.**  
USPC ..... **D14/223**

(58) **Field of Classification Search**  
USPC ..... D14/223, 205, 138 AA, 138 AB;  
181/129, 130, 135; 379/430, 431;  
381/380, 381; 455/90.3, 575.1  
CPC ..... H04R 25/00; H04R 1/10; H04R 5/033;  
H04R 5/0335

See application file for complete search history.

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*Primary Examiner* — Paula Greene

(57) **CLAIM**

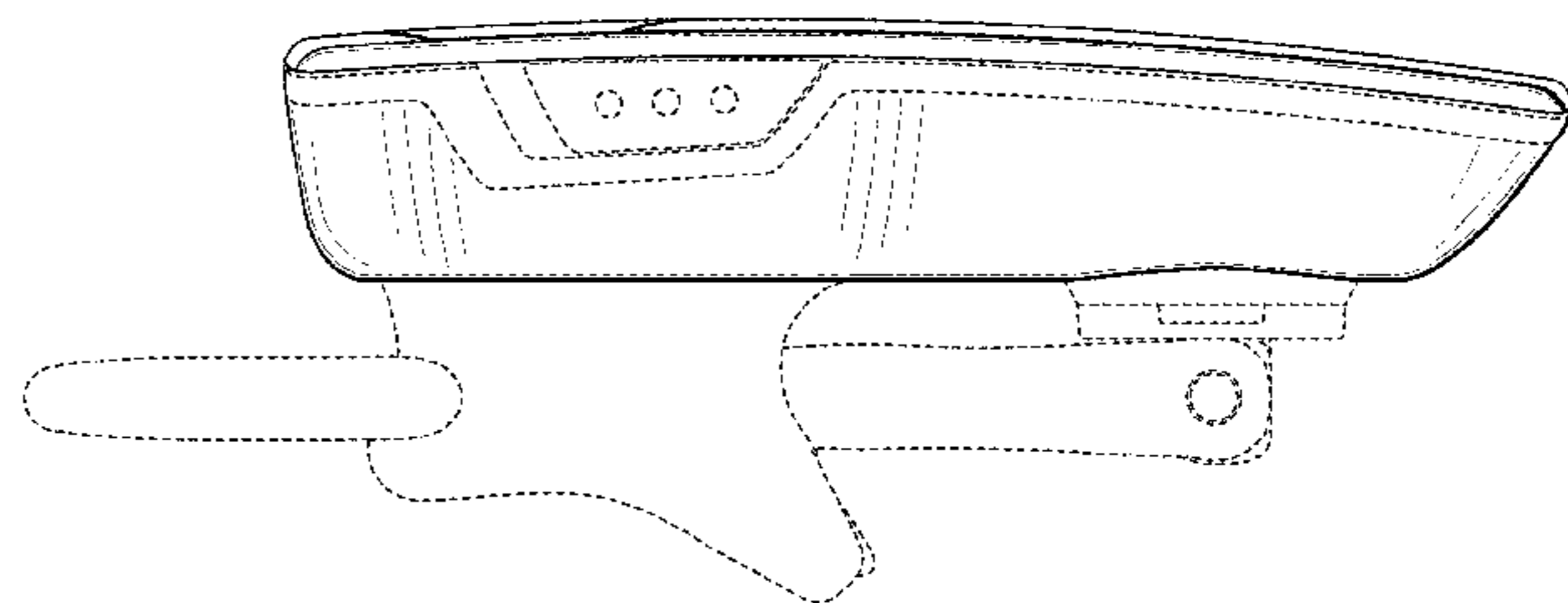
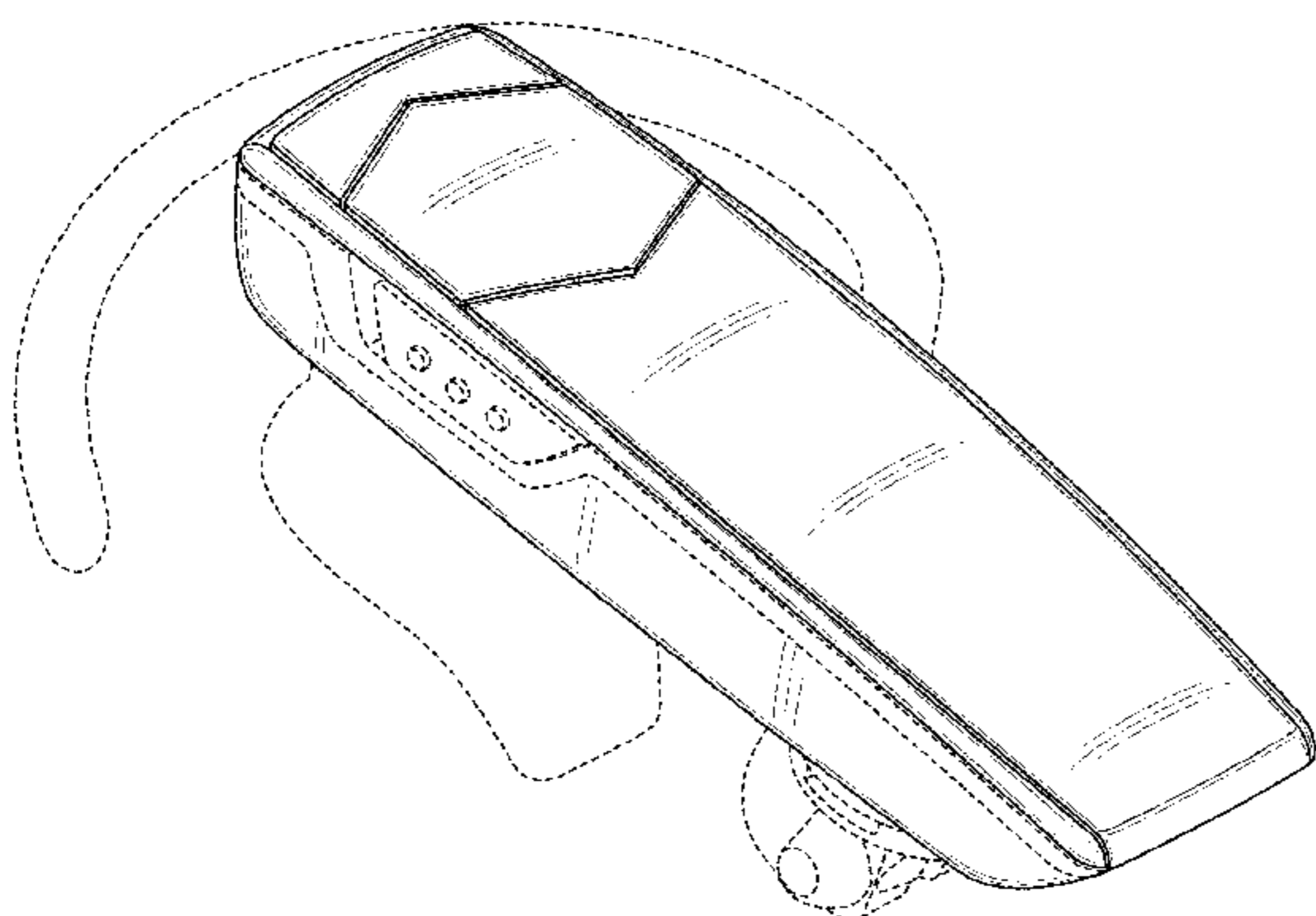
The ornamental design for a communications headset, as shown and described.

**DESCRIPTION**

FIG. 1 is a top-left perspective view of a communications headset showing my new design;  
FIG. 2 is a top-right perspective view thereof;  
FIG. 3 is a top view thereof;  
FIG. 4 is a bottom view thereof;  
FIG. 5 is a back view thereof;  
FIG. 6 is a front view thereof;  
FIG. 7 is a right side view thereof; and,  
FIG. 8 is a left side view thereof.

The broken lines in the drawings, including those immediately adjacent to the shaded areas, represent unclaimed features for an exemplary headset in which the design is embodied; the broken lines form no part of the claimed design.

**1 Claim, 6 Drawing Sheets**



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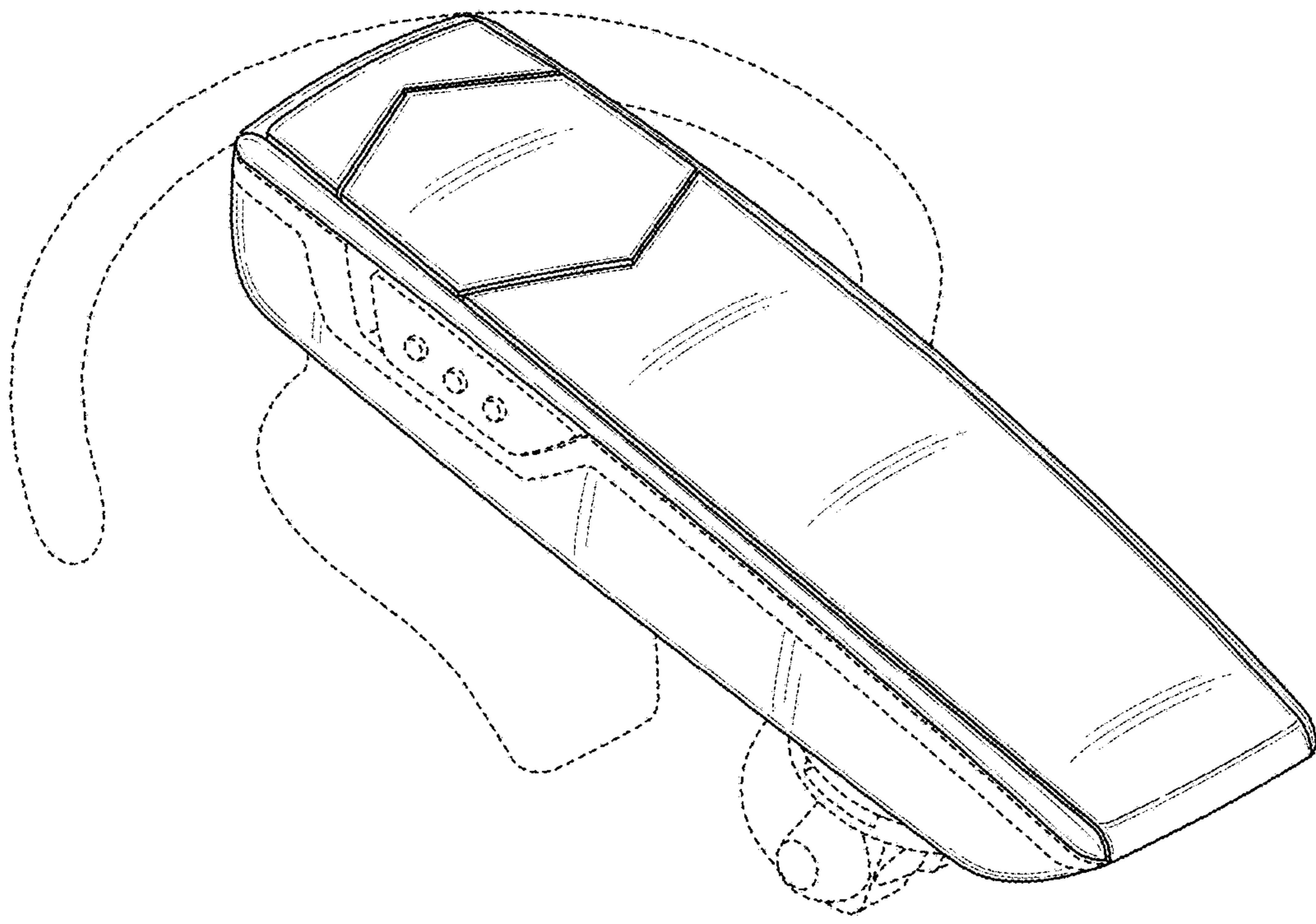


FIG. 1

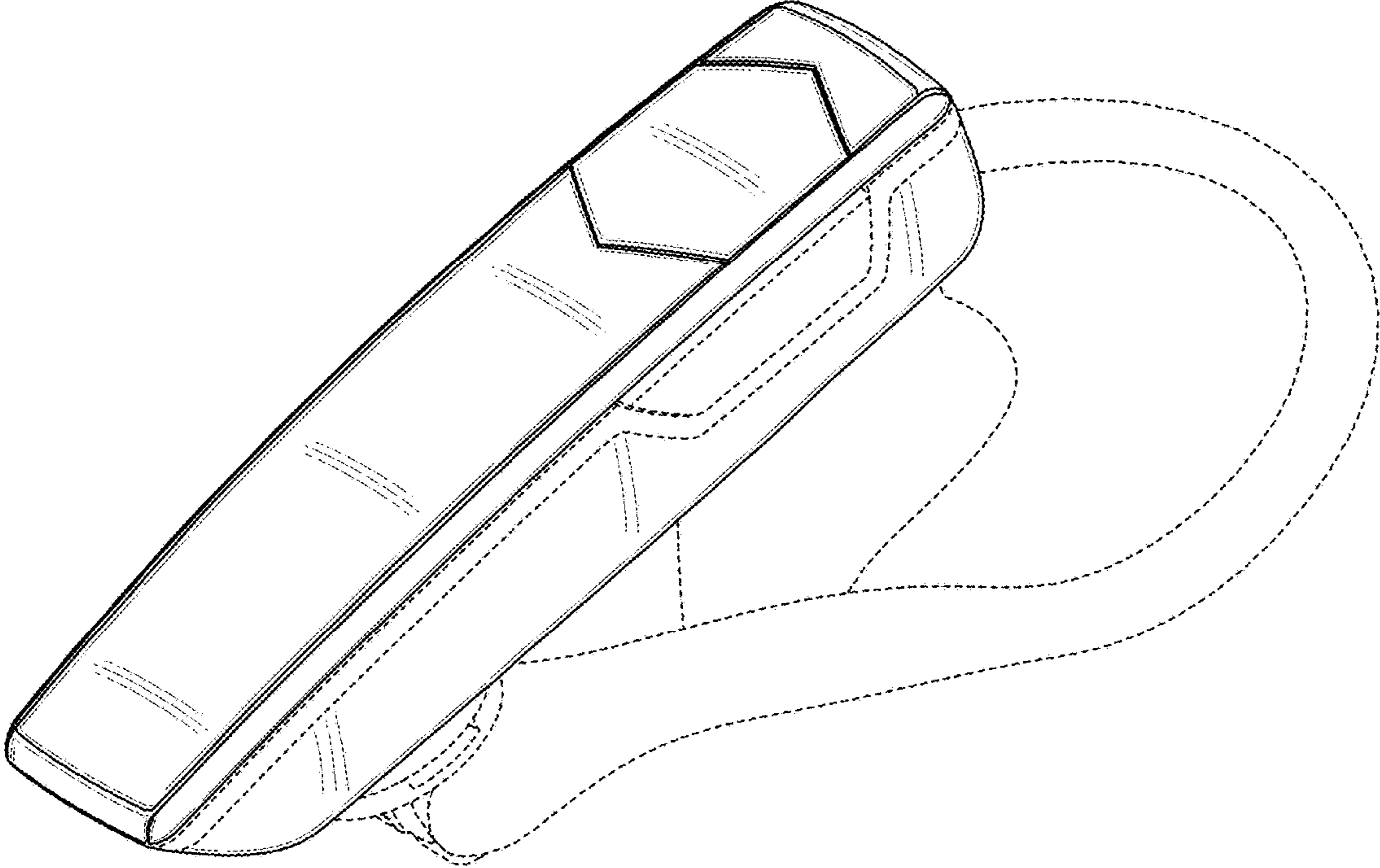


FIG. 2

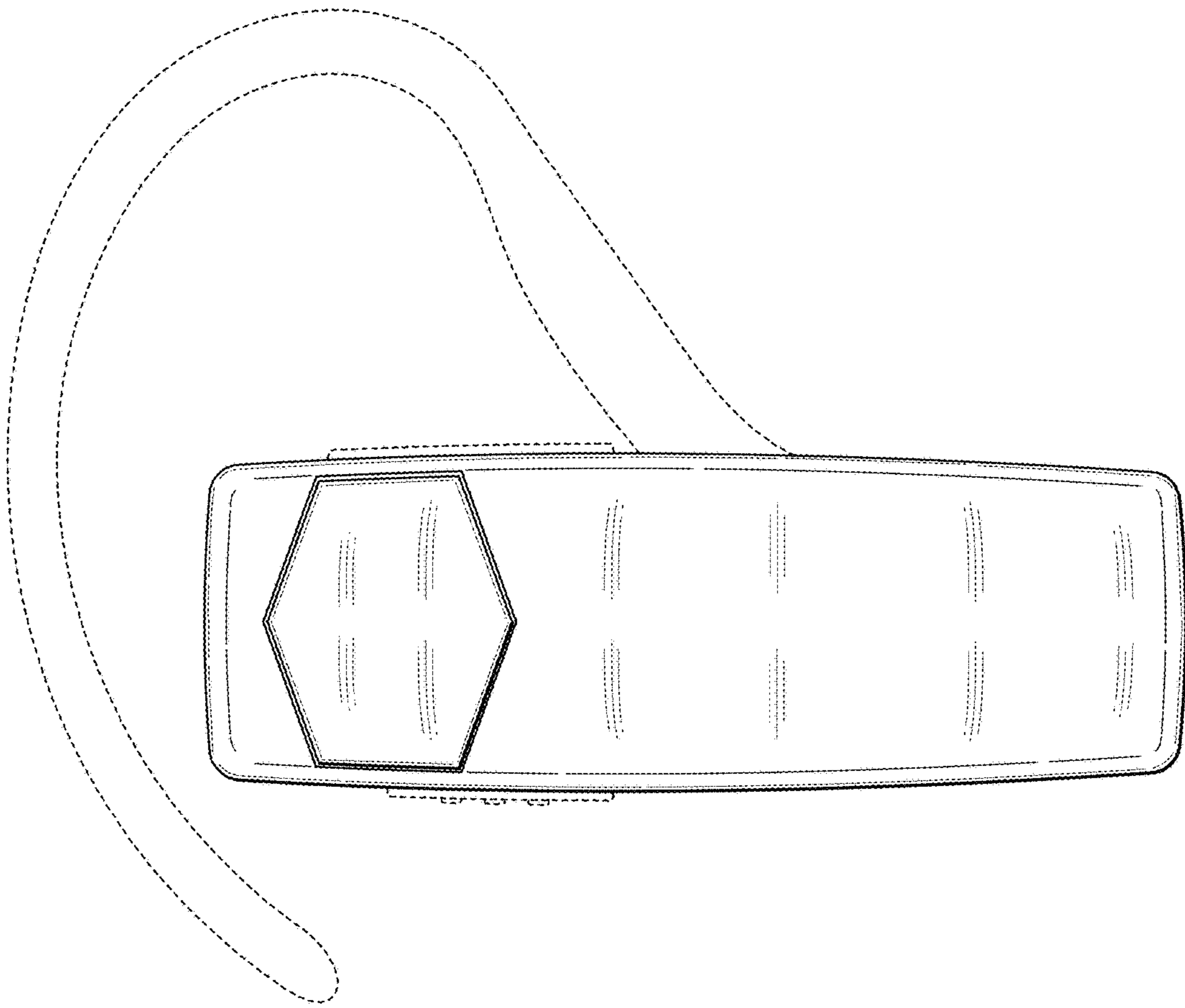


FIG. 3

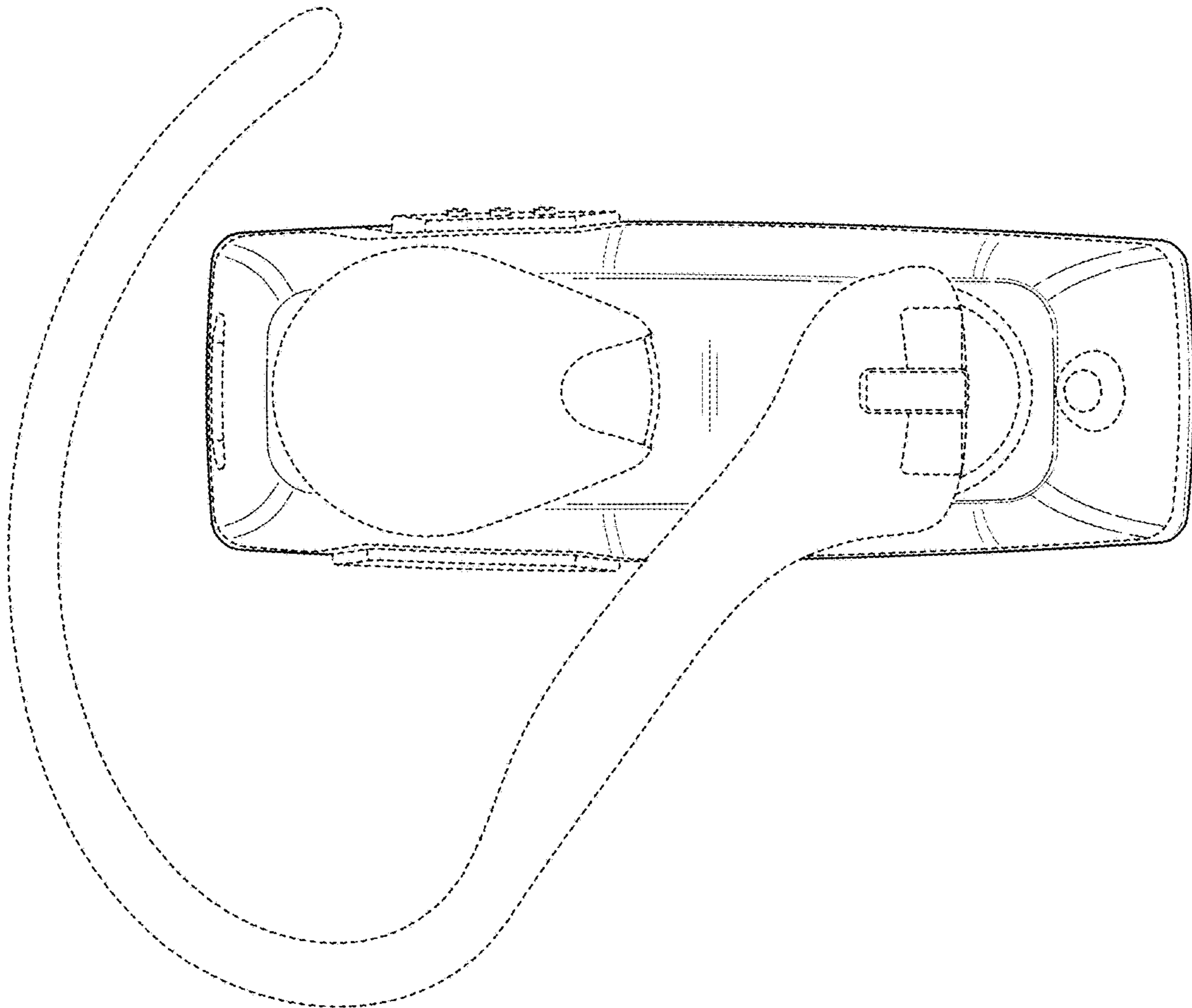


FIG. 4

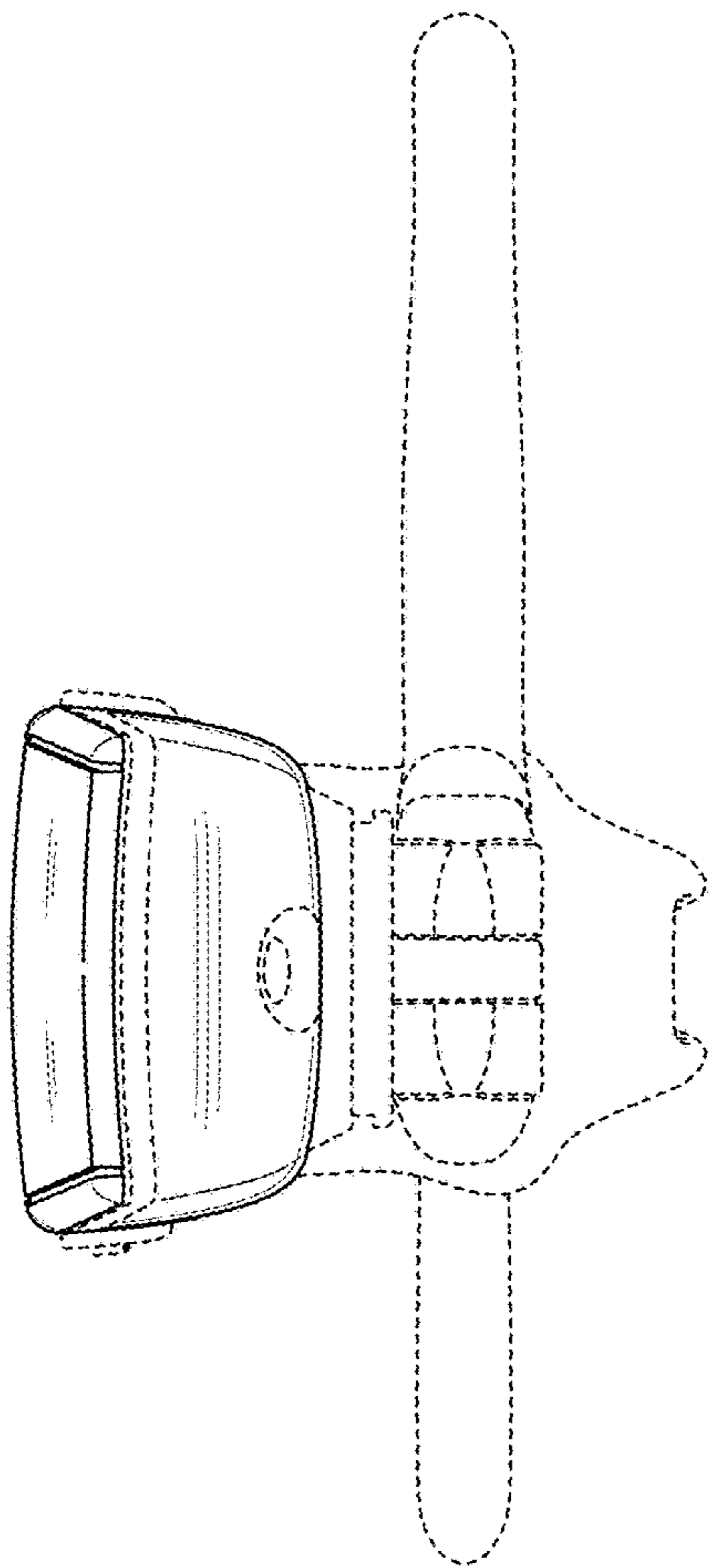


FIG. 5

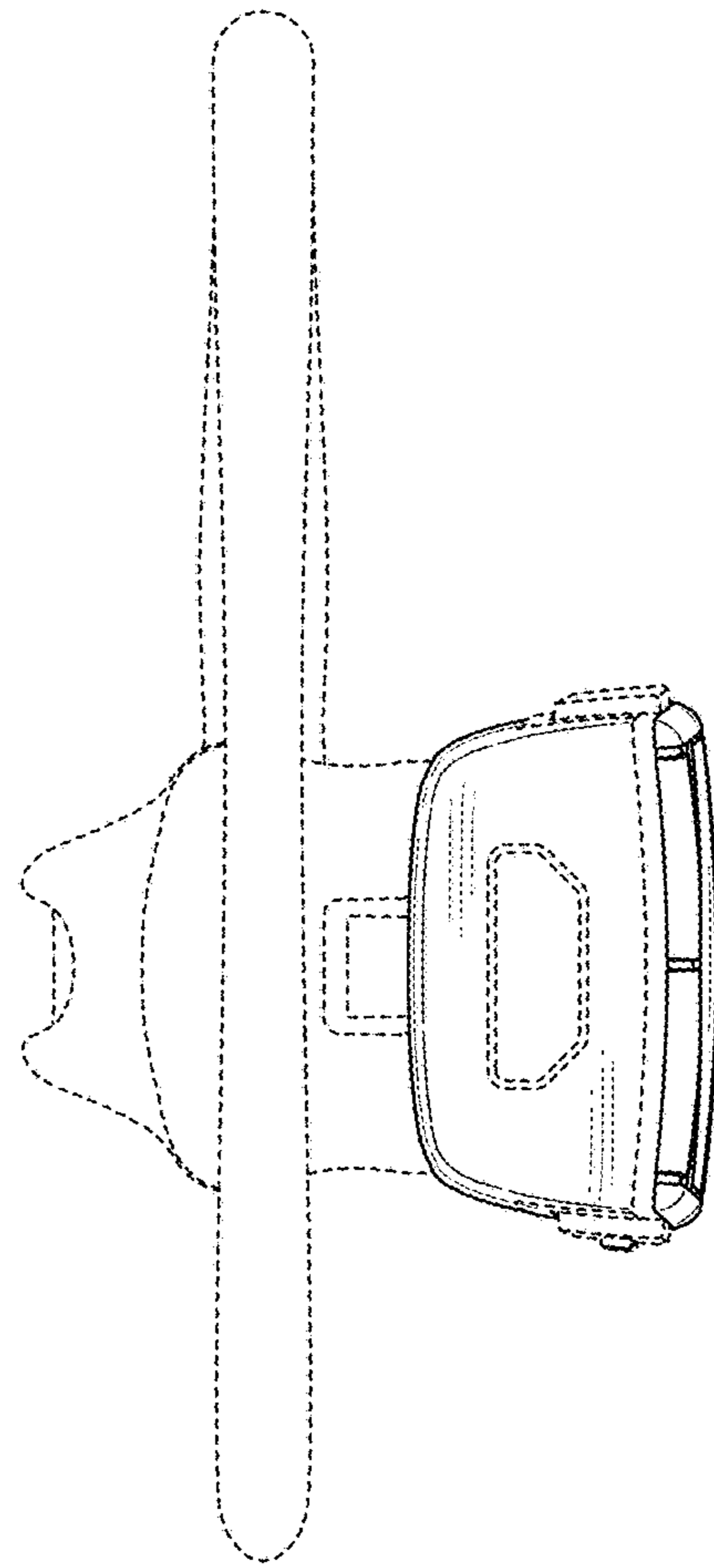


FIG. 6

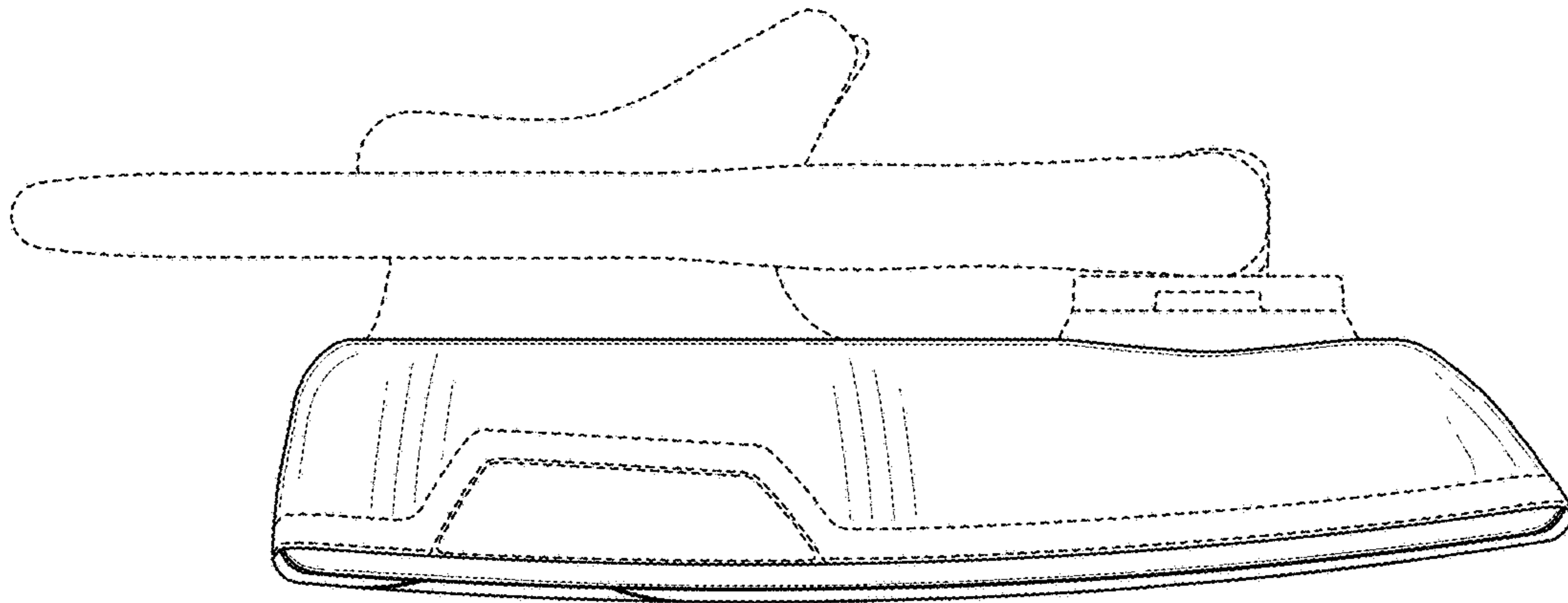


FIG. 7

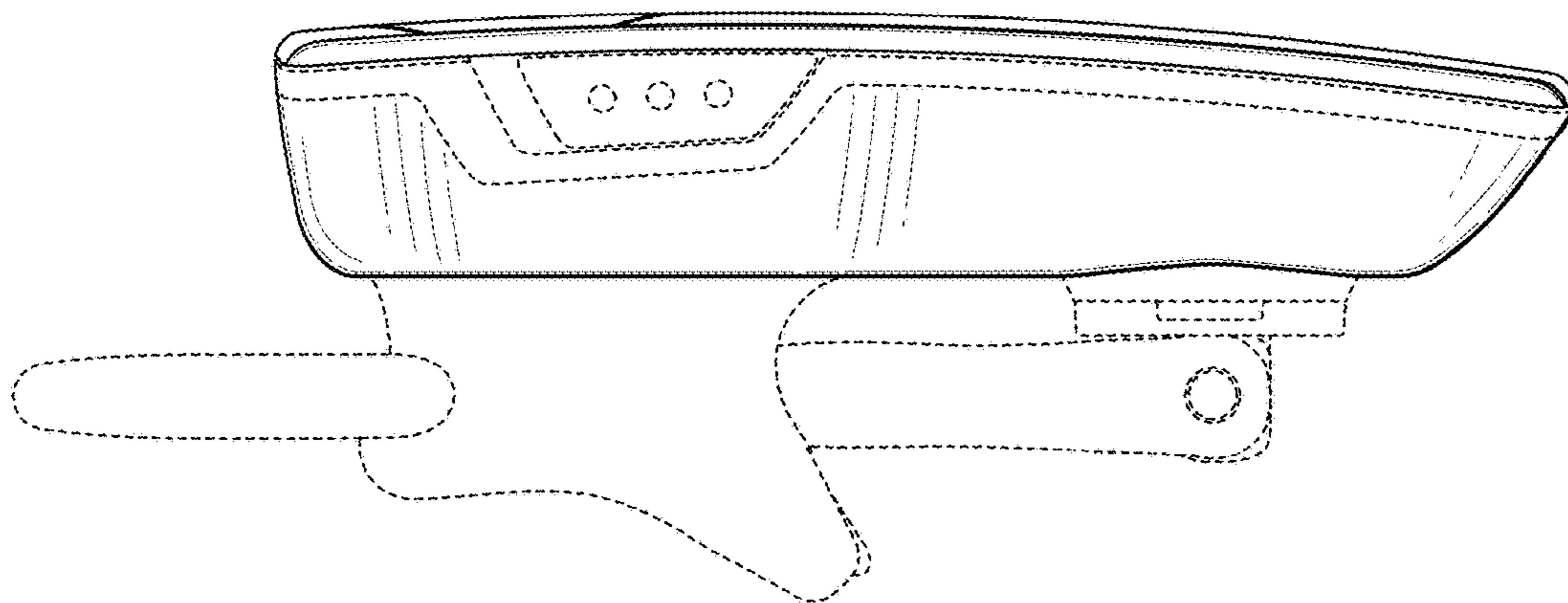


FIG. 8